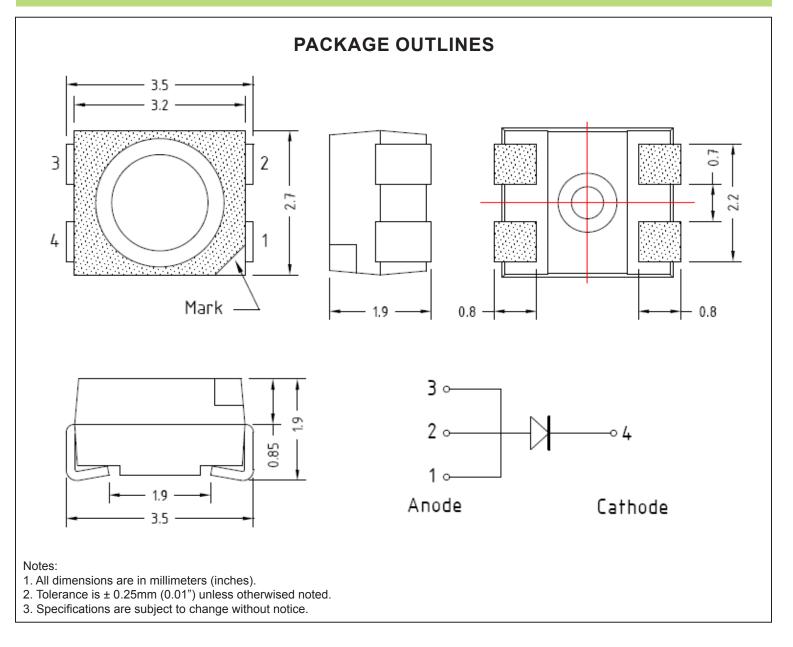


SPECIFICATION

CSP1311GT2C-4



Part Number	Chip Material	Color of Emission Lens Type		Viewing Angle	
CSP1311GT2C-4	InGaN	Green	Water Clear	120°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μΑ	
Power Dissipation	Pd	108	mW	
Operating Temperature Range	Тор	-30~+100	°C	
Storage Temperature Range	Тѕтс	-40~+100	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	100	mA	
Soldering Temperature	TSOL	Max 265°C for 10 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

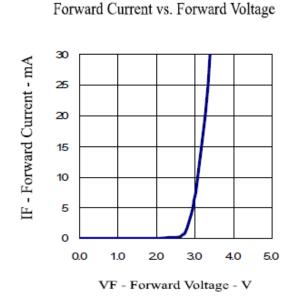
Deremeter	Symbol	Test Condition	Value			Unit
Parameter			Min	Тур	Max	Unit
Luminous Intensity	١v	IF = 20mA	1150	1400	-	mcd
Forward Voltage	Vf	IF = 20mA	-	3.2	3.6	V
Reverse Leakage Current	lr	VR = 5V	-	-	10	μA
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	120	-	Deg
Peak Wavelength	λP	IF = 20mA	-	515	-	nm
Dominant Wavelength	λD	IF = 20mA	515	525	535	nm

*Tolerance of viewing angle: -10 / +5 deg.

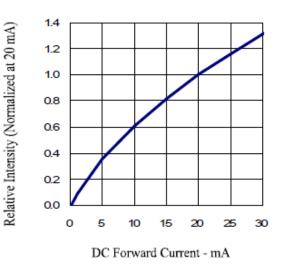




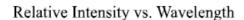
OPTICAL CHARACTERISTIC CURVES

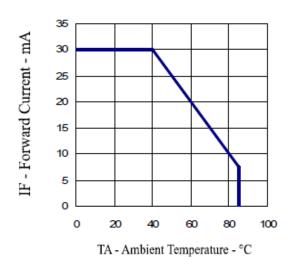


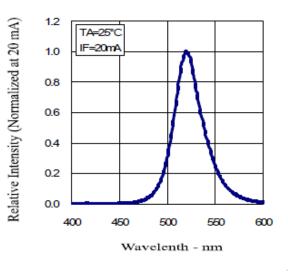
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature





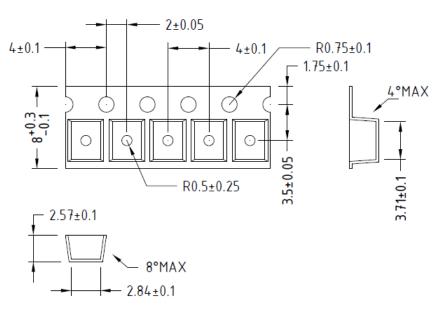




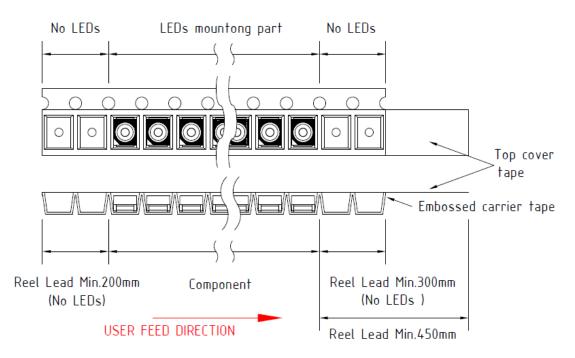


PACKAGING SPECIFICATION

TAPE DIMENSION



TAPE LEADER AND TRAILER DIMENSION



Notes:

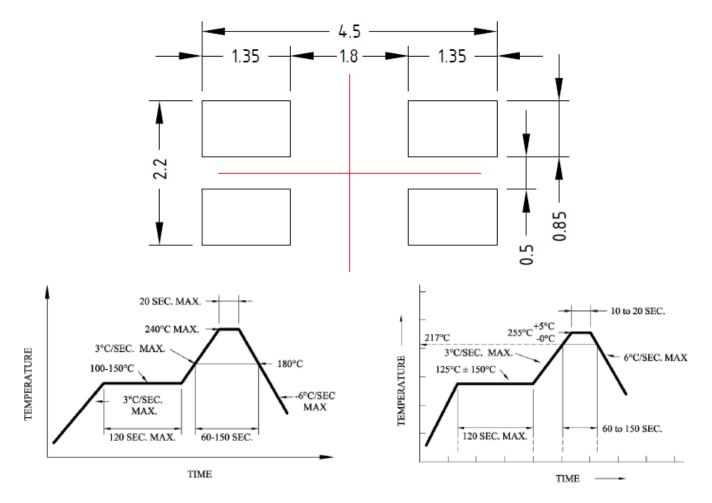
- 1. Empty component pockets are sealed with top cover tape
- 2. The maximum number of missing lamps is two.
- 3. 2000 pcs/reel



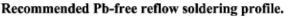


SOLDERING CONDITIONS

RECOMMENDED SOLDERING PAD PATTERN







- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board

